

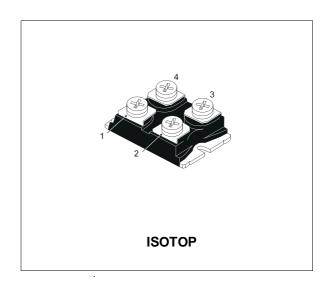
## **ESM2012DV**

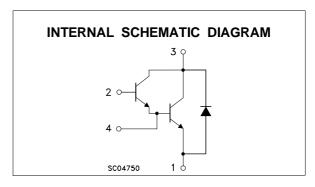
## NPN DARLINGTON POWER MODULE

- HIGH CURRENT POWER BIPOLAR MODULE
- VERY LOW Rth JUNCTION TO CASE
- SPECIFIED ACCIDENTAL OVERLOAD AREAS
- ULTRAFAST FREEWHEELING DIODE
- FULLY INSULATED PACKAGE (UL COMPLIANT)
- EASY TO MOUNT
- LOW INTERNAL PARASITIC INDUCTANCE

#### **INDUSTRIAL APPLICATIONS:**

- MOTOR CONTROL
- UPS
- DC/DC & DC/AC CONVERTERS





### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
V <sub>CEV</sub>	Collector-Emitter Voltage (V <sub>BE</sub> = -5 V)	150	V
V <sub>CEO(sus)</sub>	Collector-Emitter Voltage (I <sub>B</sub> = 0)	120	V
V <sub>EBO</sub>	Emitter-Base Voltage (I <sub>C</sub> = 0)	7	V
Ic	Collector Current	120	А
I <sub>CM</sub>	Collector Peak Current (t <sub>p</sub> = 10 ms)	180	Α
Ι <sub>Β</sub>	Base Current	2	А
I <sub>BM</sub>	Base Peak Current (tp = 10 ms)	4	Α
P <sub>tot</sub>	Total Dissipation at T <sub>c</sub> = 25 °C	175	W
V <sub>isol</sub>	Insulation Withstand Voltage (RMS) from All Four Terminals to Exernal Heatsink	2500	V
T <sub>stg</sub>	Storage Temperature	-55 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

September 2003 1/8

### THERMAL DATA

R <sub>thj-case</sub>	Thermal Resistance Junction-case (transistor)	Max	0.7	°C/W	
R <sub>thj-case</sub>	Thermal Resistance Junction-case (diode)	Max	0.9	°C/W	Ì
$R_{thc-h}$	Thermal Resistance Case-heatsink With Conductive				l
	Grease Applied	Max	0.05	°C/W	

### **ELECTRICAL CHARACTERISTICS** ( $T_{case} = 25$ $^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I <sub>CER</sub> #	Collector Cut-off Current ( $R_{BE} = 5 \Omega$ )	$V_{CE} = V_{CEV}$ $V_{CE} = V_{CEV}$ $T_j = 100$ °C			1.5 10	mA mA
I <sub>CEV</sub> #	Collector Cut-off Current (V <sub>BE</sub> = -5V)	$V_{CE} = V_{CEV}$ $V_{CE} = V_{CEV}$ $T_j = 100$ °C			1 7	mA mA
I <sub>EBO</sub> #	Emitter Cut-off Current (I <sub>C</sub> = 0)	V <sub>EB</sub> = 5 V			1	mA
VCEO(SUS)*	Collector-Emitter Sustaining Voltage (I <sub>B</sub> = 0)	$I_C = 5 A$ $L = 15 mH$ $V_{clamp} = 125 V$	125			V
h <sub>FE</sub> *	DC Current Gain	I <sub>C</sub> = 100 A V <sub>CE</sub> = 5 V		1200		
V <sub>CE(sat)</sub> *	Collector-Emitter Saturation Voltage	$\begin{array}{cccccccccccccccccccccccccccccccccccc$		1.25 1.35 1.5 1.65	1.5 2	V V V
V <sub>BE(sat)</sub> *	Base-Emitter Saturation Voltage	I <sub>C</sub> = 100 A I <sub>B</sub> = 1 A I <sub>C</sub> = 100 A I <sub>B</sub> = 1 A T <sub>j</sub> = 100 °C		2.3 2.35	3	V V
di <sub>C</sub> /dt	Rate of Rise of On-state Collector	$V_{CC} = 90 \text{ V}$ $R_C = 0$ $t_p = 3 \mu s$ $I_{B1} = 0.5 \text{ A}$ $T_j = 100  ^{\circ}\text{C}$	200	230		A/μs
V <sub>CE</sub> (3 μs)••	Collector-Emitter Dynamic Voltage	$V_{CC} = 90 \text{ V}$ $R_C = 1.3 \Omega$ $I_{B1} = 0.5 \text{ A}$ $T_j = 100 ^{\circ}\text{C}$		2	3	V
V <sub>CE</sub> (5 μs)••	Collector-Emitter Dynamic Voltage	$V_{CC} = 90 \text{ V}$ $R_C = 1.3 \Omega$ $I_{B1} = 0.5 \text{ A}$ $T_j = 100 ^{\circ}\text{C}$		1.8	2.5	V
t <sub>s</sub> t <sub>f</sub> t <sub>c</sub>	Storage Time Fall Time Cross-over Time	$\begin{array}{lll} I_{C} = 70 \; A & V_{CC} = 90 \; V \\ V_{BB} = -5 \; V & R_{BB} = \Omega \\ V_{clamp} = 125 \; V & I_{B1} = 0.25 \; A \\ L = 60 \; \mu H & T_{j} = 100 \; ^{\circ}C \end{array}$		0.9 0.15 0.3	2 0.3 0.6	μs μs μs
V <sub>CEW</sub>	Maximum Collector Emitter Voltage Without Snubber	$\begin{array}{lll} I_{CWoff} = 120 \; A & I_{B1} = 1A \\ V_{BB} = -5 \; V & V_{CC} = 90 \; V \\ L = 60 \; \mu H & R_{BB} = 1.25 \; \Omega \\ T_j = 125 \; ^{\circ}C \end{array}$	125			V
V <sub>F</sub> *	Diode Forward Voltage	I <sub>F</sub> = 100 A T <sub>j</sub> = 100 °C		0.92	1	٧
I <sub>RM</sub>	Reverse Recovery Current	$V_{CC} = 125 \text{ V}$ $I_F = 100 \text{ A}$ $di_F/dt = -200 \text{ A}/\mu\text{s}$ $L < 0.05 \mu\text{H}$ $T_j = 100 ^{\circ}\text{C}$		10	14	A

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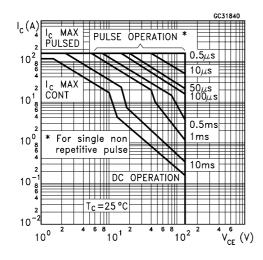
<sup>\*</sup> Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %

# See test circuits in databook introduction

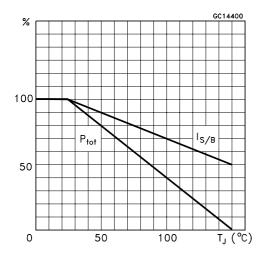
To evaluate the conduction losses of the diode use the following equations:

 $V_F = 0.66 + 0.0034 \; I_F \qquad P = 0.66 \; I_{F(AV)} + 0.0034 \; I^2_{F(RMS)} \label{eq:proposed}$ 

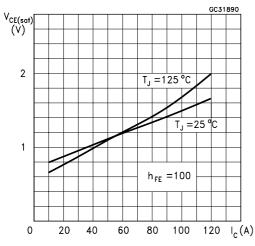
### Safe Operating Areas



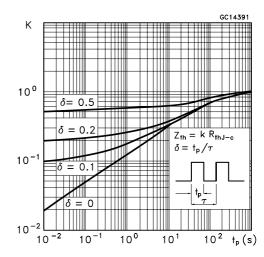
### **Derating Curve**



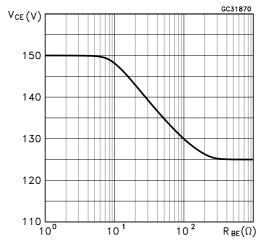
### Collector Emitter Saturation Voltage



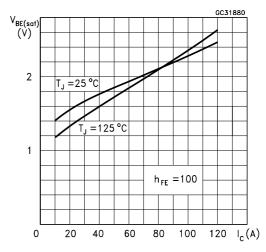
### Thermal Impedance



# Collector-emitter Voltage Versus base-emitter Resistance

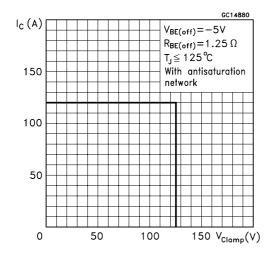


### Base-Emitter Saturation Voltage

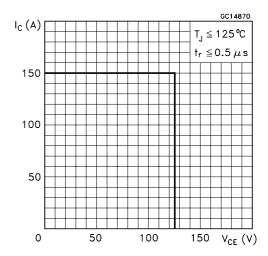


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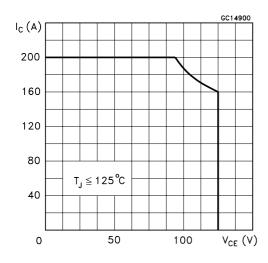
### Reverse Biased SOA



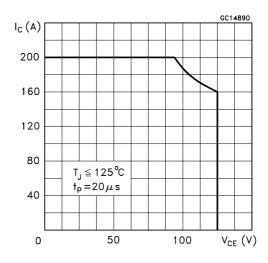
### Foward Biased SOA



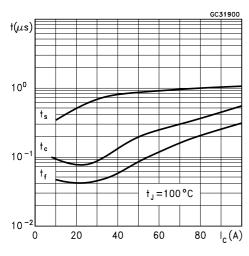
#### Reverse Biased AOA



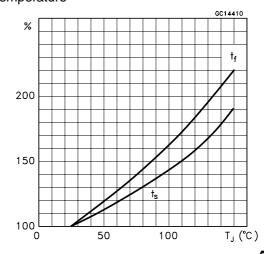
Forward Biased AOA



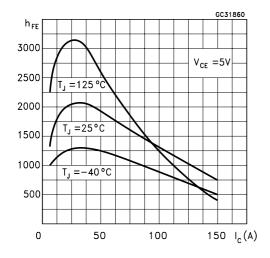
### Switching Times Inductive Load



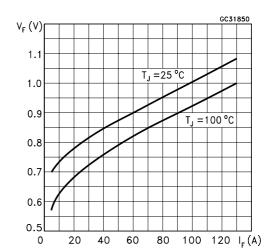
# Switching Times Inductive Load Versus Temperature



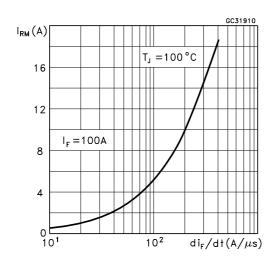
### Dc Current Gain



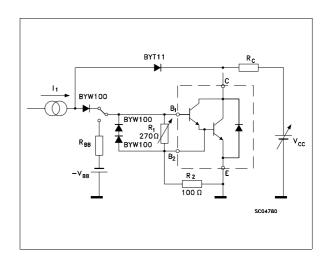
Typical  $V_F$  Versus  $I_F$ 



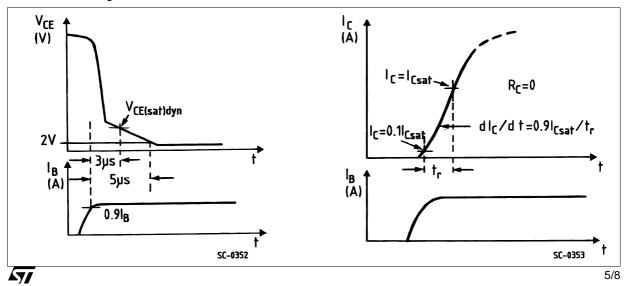
Peak Reverse Current Versus diF/dt



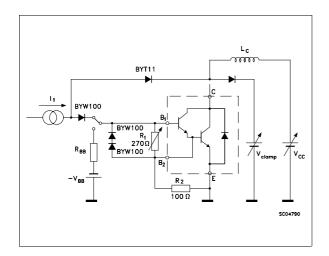
Turn-on Switching Test Circuit



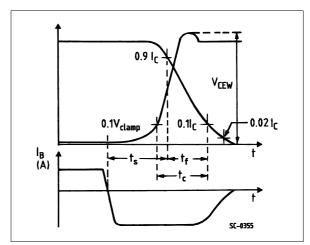
Turn-on Switching Waveforms



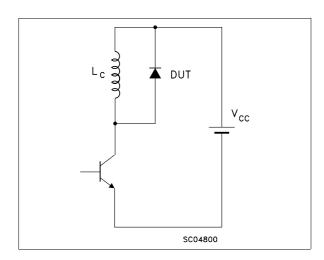
### Turn-on Switching Test Circuit



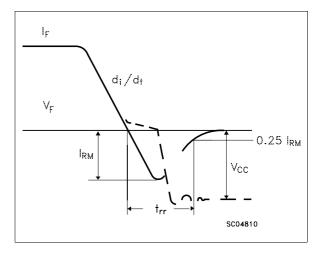
Turn-off Switching Waveforms



Turn-off Switching Test Circuit of Diode

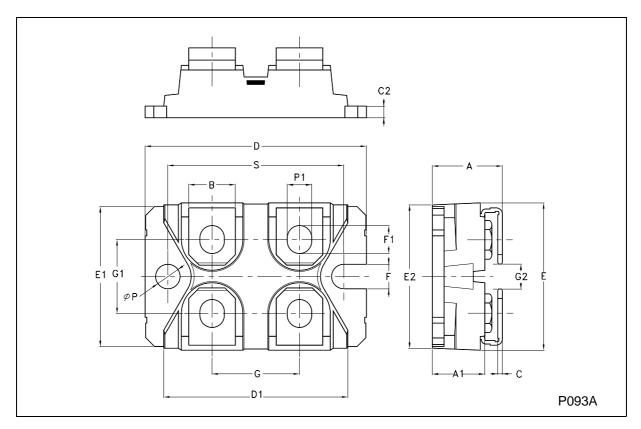


Turn-off Switching Waveform of Diode



### **ISOTOP MECHANICAL DATA**

DIM.	mm		inch			
DIN.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
Α	11.8		12.2	0.465		0.480
A1	8.9		9.1	0.350		0.358
В	7.8		8.2	0.307		0.322
С	0.75		0.85	0.029		0.033
C2	1.95		2.05	0.076		0.080
D	37.8		38.2	1.488		1.503
D1	31.5		31.7	1.240		1.248
E	25.15		25.5	0.990		1.003
E1	23.85		24.15	0.938		0.950
E2		24.8			0.976	
G	14.9		15.1	0.586		0.594
G1	12.6		12.8	0.496		0.503
G2	3.5		4.3	0.137		1.169
F	4.1		4.3	0.161		0.169
F1	4.6		5	0.181		0.196
Р	4		4.3	0.157		0.169
P1	4		4.4	0.157		0.173
S	30.1		30.3	1.185		1.193



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